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# onsemi

# TinyLogic UHS Two-Input Exclusive-OR Gate

# NC7SZ86

#### Description

The NC7SZ86 is a single two-input exclusive-OR gate from **onsemi**'s Ultra-High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad VCC operating range. The device is specified to operate over the 1.65 V to 5.5 V V<sub>CC</sub> operating range. The inputs and output are high impedance when V<sub>CC</sub> is 0 V. Inputs tolerate voltages up to 5.5 V, independent of V<sub>CC</sub> operating voltage.

#### Features

- Ultra-High Speed:  $t_{PD} = 2.9$  ns (Typical) into 50 pF at 5 V V<sub>CC</sub>
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX Operated at 3.3 V V<sub>CC</sub>
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra–Small MicroPak<sup>TM</sup> Packages
- Space-Saving SOT23-5, SC-74A and SC-88A Packages
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

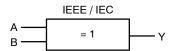
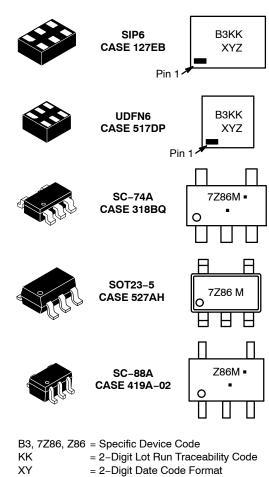
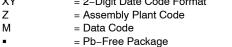


Figure 1. Logic Symbol





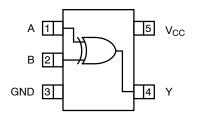
(Note: Microdot may be in either location)

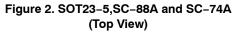
#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet. NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 6.

MARKING DIAGRAMS

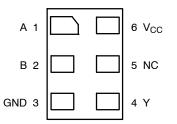
### **Pin Configurations**





#### **PIN DEFINITIONS**

Pin # SC-88A / SC74A/SOT23-5	Pin # MicroPak	Name	Description
1	1	А	Input
2	2	В	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V <sub>CC</sub>	Supply Voltage
	5	NC	No Connect



#### Figure 3. MicroPak (Top Through View)

### **FUNCTION TABLE**

Inp	uts	Output
А	В	Y
L	L	L
L	н	Н
н	L	Н
Н	Н	L

H = HIGH Logic Level L = LOW Logic Level

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter		Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IN</sub>	DC Input Voltage		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.5	V
Ι <sub>ΙΚ</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-50	mA
I <sub>OUT</sub>	DC Output Current		-	±50	mA
$I_{CC} \text{ or } I_{GND}$	DC V <sub>CC</sub> or Ground Current		-	±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bias		-	+150	°C
ΤL	Junction Lead Temperature (Sold	ering, 10 Seconds)	-	+260	°C
PD	Power Dissipation in Still Air	SC-74A / SOT23-5	-	390	mW
		SC-88A	-	332	
		MicroPak-6	-	812	
		MicroPak2™–6	-	812	
ESD	Human Body Model, JEDEC: JES	D22-A114	-	2000	V
	Charge Device Model, JEDEC: JE	ESD22-C101	-	1000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.5	V
	Supply Voltage Data Retention		1.5	5.5	
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Times	$V_{CC}$ = 1.8 V, 2.5 V ±0.2 V	0	20	ns/V
		$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$	0	10	
		$V_{CC} = 5.0 \text{ V} \pm 0.5 \text{ V}$	0	5	
$\theta_{JA}$	Thermal Resistance	SC-74A / SOT23-5	-	320	°C/W
		SC-88A	-	377	
		MicroPak-6	-	154	
		MicroPak2-6	-	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. Unused inputs must be held HIGH or LOW. They may not float.

## NC7SZ86

### DC ELECTICAL CHARACTERISTICS

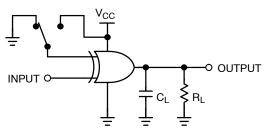
				T <sub>A</sub> = +25°C			T <sub>A</sub> = −40 to +85°C		
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
VIH	HIGH Level Input Voltage	1.65 to 1.95		0.65 V <sub>CC</sub>	-	-	0.65 V <sub>CC</sub>	-	V
		2.30 to 5.50		0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-	
V <sub>IL</sub>	LOW Level Input Voltage	1.65 to 1.95		-	-	0.35 V <sub>CC</sub>	-	0.35 V <sub>CC</sub>	V
		2.30 to 5.50		-	-	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>	
V <sub>OH</sub>	HIGH Level Output Voltage	1.65	$V_{IN} = V_{IH} \text{ or } V_{IL}$	1.55	1.65	-	1.55	-	V
		1.80	I <sub>OH</sub> = -100 μA	1.70	1.80	-	1.70	-	
		2.30		2.20	2.30	-	2.20	-	
		3.00		2.90	3.00	-	2.90	-	
		4.50		4.40	4.50	-	4.40	_	
		1.65	I <sub>OH</sub> = -4 mA	1.29	1.52	-	1.29	_	
		2.30	I <sub>OH</sub> = -8 mA	1.90	2.15	-	1.90	_	
		3.00	I <sub>OH</sub> = -16 mA	2.40	2.80	-	2.40	_	
		3.00	I <sub>OH</sub> = -24 mA	2.30	2.68	-	2.30	_	
		4.50	I <sub>OH</sub> = -32 mA	3.80	4.20	-	3.80	_	
V <sub>OL</sub>	LOW Level Output Voltage	1.65	$V_{IN} = V_{IH} \text{ or } V_{IL}$	-	0.00	0.10	_	0.10	V
		1.80	I <sub>OL</sub> = 100 μA	-	0.00	0.10	_	0.10	
		2.30		-	0.00	0.10	_	0.10	
		3.00		-	0.00	0.10	-	0.10	1
		4.50		-	0.00	0.10	-	0.10	
		1.65	I <sub>OL</sub> = 4 mA	-	0.80	0.24	-	0.24	
		2.30	I <sub>OL</sub> = 8 mA	-	0.10	0.30	-	0.30	
		3.00	I <sub>OL</sub> = 16 mA	-	0.15	0.40	-	0.40	
		3.00	I <sub>OL</sub> = 24 mA	-	0.22	0.55	-	0.55	1
		4.50	I <sub>OL</sub> = 32 mA	-	0.22	0.55	-	0.55	1
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, GND	-	-	±1	-	±10	μA
I <sub>OFF</sub>	Power Off Leakage Current	0	$V_{IN}$ or $V_{OUT}$ = 5.5 V	-	-	1	-	10	μA
I <sub>CC</sub>	Quiescent Supply Current	1.65 to 5.5	V <sub>IN</sub> = 5.5 V, GND	-	-	2	-	20	μA

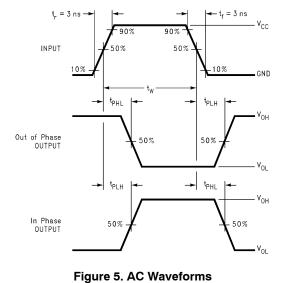
### **NC7SZ86**

#### **AC ELECTRICAL CHARACTERISTICS**

					Γ <sub>A</sub> = +25°C	;	T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> , t <sub>PHL</sub>		1.65	C <sub>L</sub> = 15 pF,	_	6.9	13.8	-	14.5	ns
	(Figure 4, 5)	1.80	$R_L = 1 M\Omega$	_	5.7	11.5	-	12.0	
		2.50 ±0.20	1	_	3.8	8.0	-	8.5	
		3.30 ±0.30		_	3.0	5.7	-	6.0	
		5.00 ±0.50		_	2.4	5.0	-	5.4	
		3.30 ±0.30	$C_{L} = 50 \text{ pF},$	_	3.5	6.2	-	6.5	
		5.00 ±0.50	$R_L = 500 \Omega$	_	2.9	5.4	-	5.8	
C <sub>IN</sub>	Input Capacitance	0.00		_	4	-	-	-	pF
	Power Dissipation Capacitance	3.30		-	25	-	-	-	pF
	(Note 2) (Figure 6)	5.00	1	-	31	-	-	-	

 C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC} \text{static}).$ 

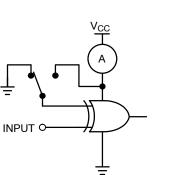




NOTE:

3. C\_L includes load and stray capacitance; Input PRR = 10 MHz;  $t_W$  = 500 ns





NOTE: 4. Input = AC Waveform;  $t_r = t_f = 1.8$  ns; PRR = 10 MHz; Duty Cycle = 50%.





#### **ORDERING INFORMATION**

Part Number	Top Mark	Package	Shipping <sup>†</sup>
NC7SZ86M5X	7Z86	SC-74A	3000 / Tape & Reel
NC7SZ86P5X	Z86	SC-88A	3000 / Tape & Reel
NC7SZ86L6X	B3	SIP6, MicroPak	5000 / Tape & Reel
NC7SZ86FHX	B3	UDFN6, MicroPak2	5000 / Tape & Reel

#### **DISCONTINUED** (Note 5)

NC7SZ86M5X-L22090	7Z86	SOT23-5	3000 / Tape & Reel
NC7SZ86L6X-L22175	B3	SIP6, MicroPak	5000 / Tape & Reel
NC7SZ86FHX-L22175	B3	UDFN6, MicroPak2	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
5. DISCONTINUED: These devices are not recommended for new design. Please contact your onsemi representative for information. The

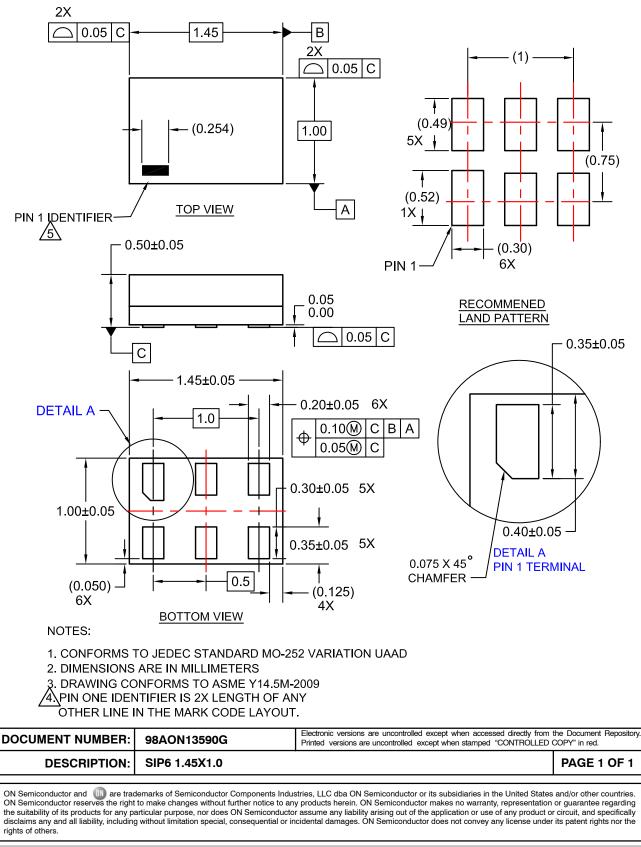
most current information on these devices may be available on www.onsemi.com.

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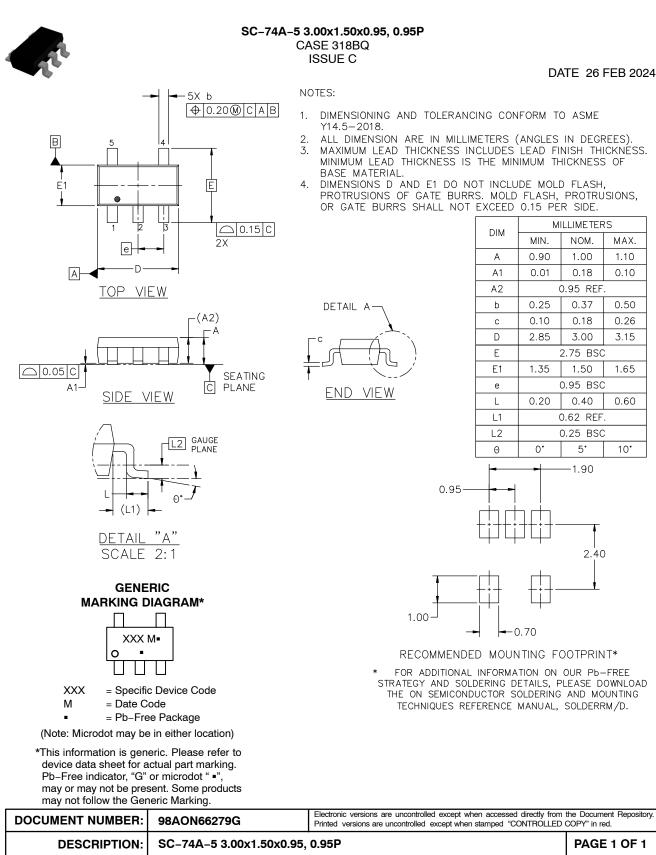


SIP6 1.45X1.0 CASE 127EB ISSUE O

DATE 31 AUG 2016



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# onsemí



#### SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

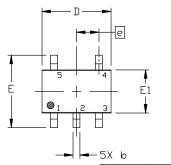
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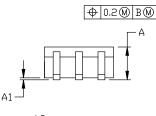
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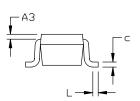
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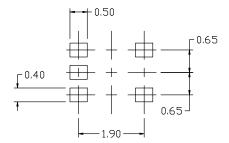
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DATE 11 APR 2023









#### RECOMMENDED MOUNTING FOOTPRINT

 For additional information our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

DIM	MI	MILLIMETERS			
DIN	MIN.	NDM.	MAX.		
Α	0.80	0.95	1.10		
A1			0.10		
A3		0.20 REF			
b	0.10	0.20	0.30		
C	0.10		0.25		
D	1.80	2.00	2,20		
E	2.00	2.10	2.20		
E1	1.15	1.25	1.35		
e	0.65 BSC				
L	0.10	0.15	0.30		

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,

PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS,

OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

CONTROLLING DIMENSION: MILLIMETERS 419A-01 DBSDLETE, NEW STANDARD 419A-02

## **GENERIC MARKING**





\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

(Note: Microdot may be in either location)

STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE	STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1	STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2	STYLE 5: PIN 1. CATHODE 2. COMMON ANOD 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4	-		
STYLE 6: PIN 1. EMITTER 2 2. BASE 2	STYLE 7: PIN 1. BASE 2. EMITTER	STYLE 8: PIN 1. CATHODE 2. COLLECTOR	STYLE 9: PIN 1. ANODE 2. CATHODE	Note: Please refer to style callout. If style ty	ype is not called		
3. EMITTER 1 4. COLLECTOR	3. BASE 4. COLLECTOR	3. N/C 4. BASE	3. ANODE 4. ANODE	out in the datasheet r datasheet pinout or p			
5. COLLECTOR 2/BASE	1 5. COLLECTOR	5. EMITTER	5. ANODE	datasheet pinout of p	in assignment.		
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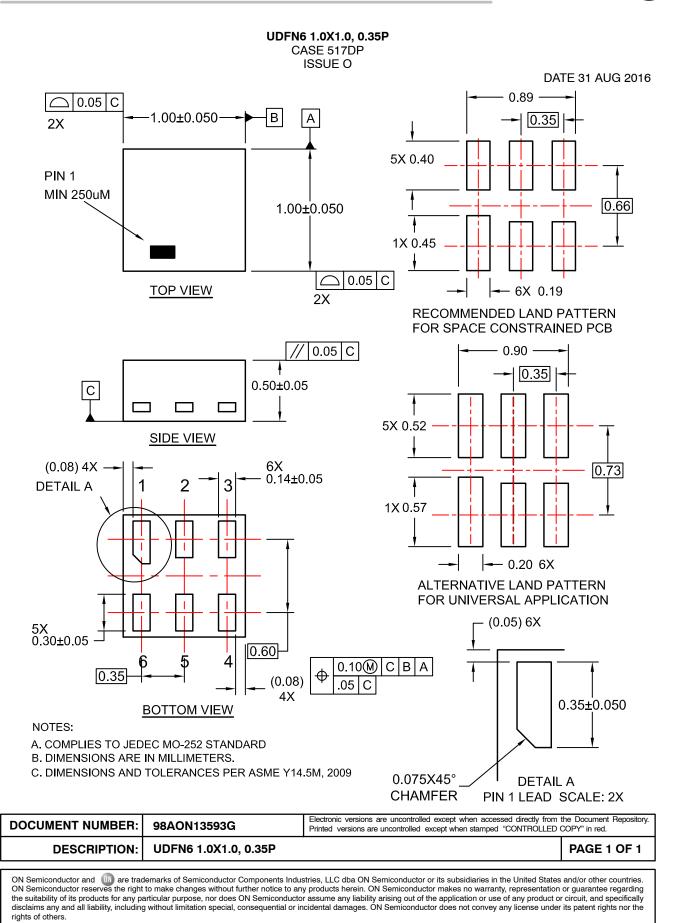
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XXX = Specific Device Code

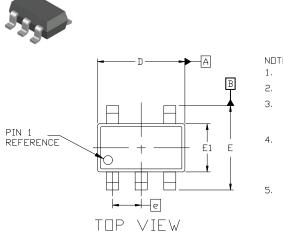
M = Date Code = Pb-Free Package





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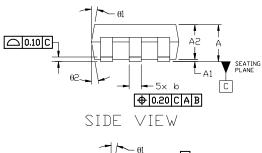


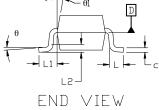
#### SOT-23, 5 Lead CASE 527AH **ISSUE A**

DATE 09 JUN 2021

NDTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
- DIMENSION 'b' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE 'b' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.





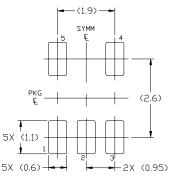
GENERIC **MARKING DIAGRAM\*** 



XXX = Specific Device Code = Date Code М

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

	MIL	MILLIMETERS			
DIM	MIN.	NDM.	MAX.		
Α	0.90	—	1.45		
A1	0.00	—	0.15		
A2	0.90	1.15	1.30		
b	0.30	—	0.50		
С	0.08	_	0.22		
D	2.90 BSC				
E	2.80 BSC				
E1	1	.60 BSC			
e	0	.95 BSC			
L	0.30	0.45	0.60		
L1	0	0.60 REF			
L2	0	.25 REF			
θ	0*	4*	8*		
01	0*	10°	15°		
θ <b>2</b>	0°	10*	15°		



#### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	SOT–23, 5 LEAD		PAGE 1 OF 1			

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